





## Introduction

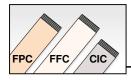
Created in 1989, FCI - an Areva Group company - rapidly secured its place among the world's top three manufacturers of connectors and interconnect systems.

With a turnover of 1.56 billion Euros (1.47 billion dollars) in 2002, FCI currently operates in 29 countries where it covers the following markets: communications, data, consumer, automotive and electrical power interconnect.

The company employs about 14 000 staff worldwide.

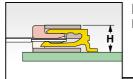
For more information: www.fciconnect.com

## Selection Innovation Reliability Economy



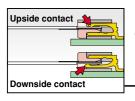
### Circuitry and cable

Flexible Printed Circuit (FPC)
Flexible Flat Cable (FFC)
Conductive Ink Circuitry (CIC)



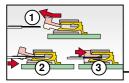
#### Low profile body heights

Permit low PCB clearance



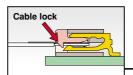
# Upper or lower contact orientation

Provides design flexibility



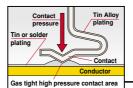
### **Zero Insertion Force (ZIF)**

Allows easy cable insertion (cable is pre-held by slider) for a reliable connection



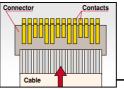
### Cable Lock alignment system

Ensures proper alignment during mating and prevents unintentional cable release



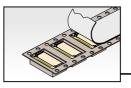
# Gas Tight High pressure (GTH) contact system

Provides highly-reliable contact performance



### Low Insertion Force (LIF)

Special contact arrangement provides reliable and easy mating operation



# Embossed Tape-and-Reel packaging

Supports automated PCB assembly process



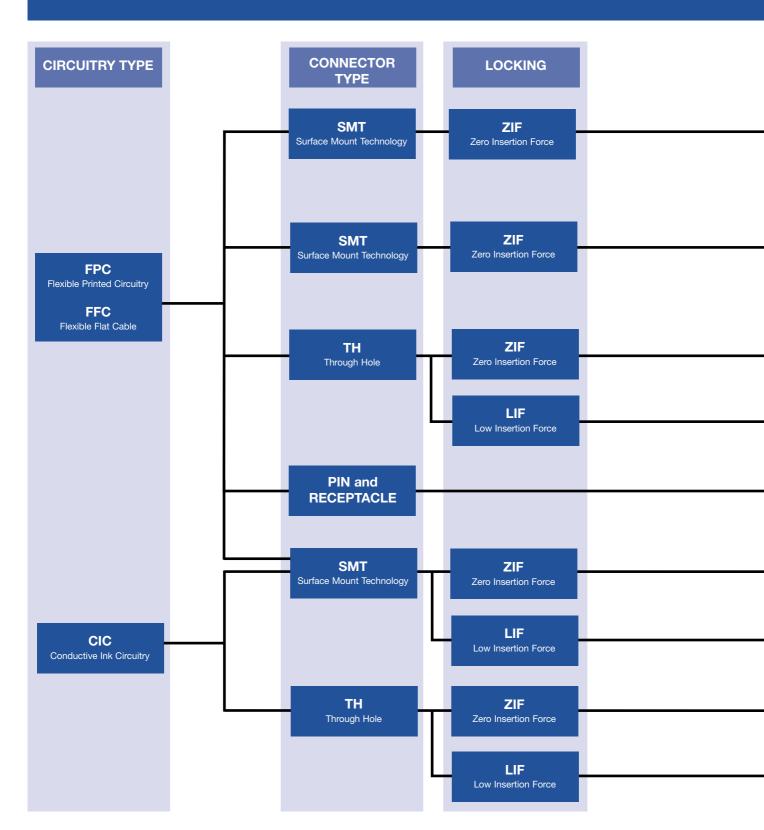
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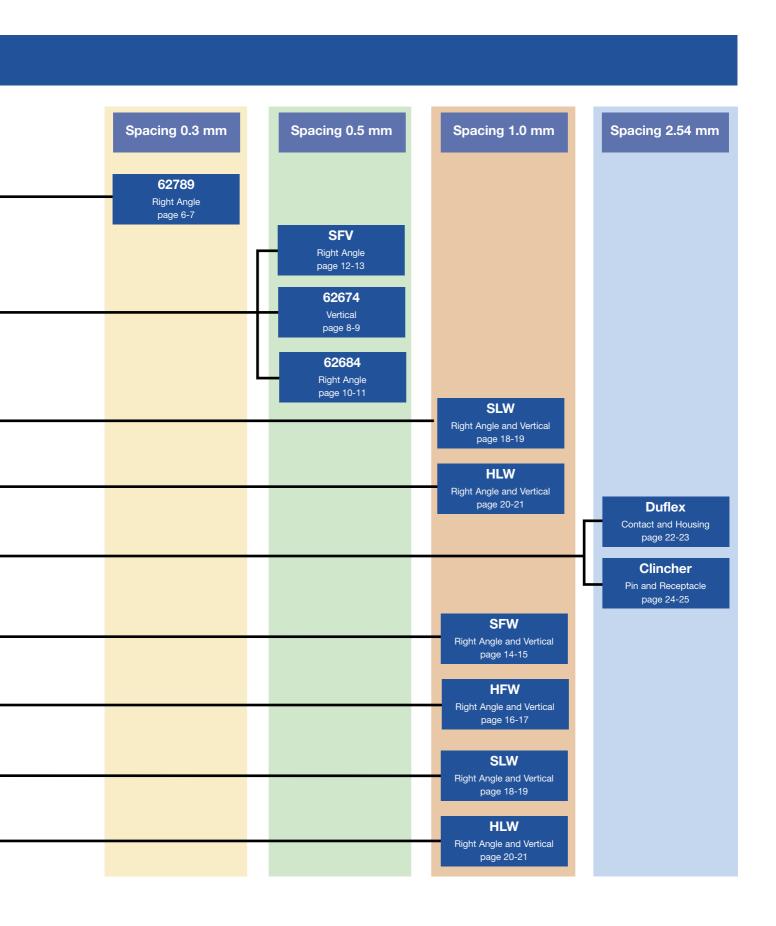
Technical Support / Drawings / Specifications / www.fciconnect.com



## **Product Chart**





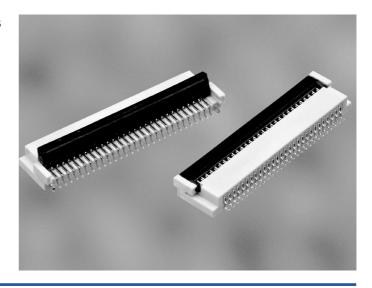




## 0.30 mm Spacing for FPC

#### **Features**

- Available in 27, 33, 39, 45, 51, 57, 67 positions
- Right angle
- Excellent cable retention with small size slider



#### **Benefits**

- Low profile of 2.00 mm
- Flip-Top cover rotates back 100 degrees for easy cable positioning.
- Staggered PCB layout enables space savings and easy soldering.
- The Zero Insertion Force (ZIF) connection allows an increased number of mating cycles with minimal wear.
- The ZIF pre-holding process provides a stable and reliable mating operation.

## **Technical Data**

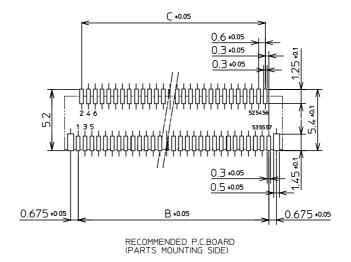
### PC Board pattern (component side)

#### **Material**

Housing: Thermoplastic Resin, White
Slider: Thermoplastic Resin, Black
Contact: Phosphor Bronze, Tin alloy plated



**B** = 0.30 x total number of positions - 0.30 **C** = 0.30 x total number of positions - 0.90





## 0.30 mm Spacing for FPC

## **Ordering Data**

**Series** 

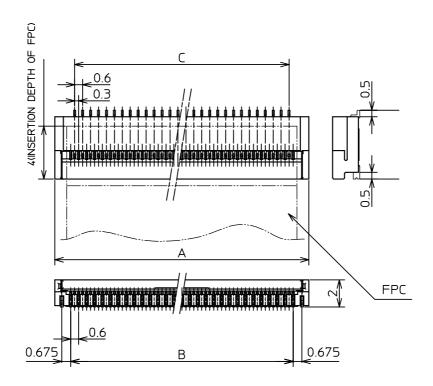
62789 - Positions 1100

**Number of contacts** 27, 33, 39, 45, 51, 57, 67 (for other number of positions, please contact FCI)

**Packaging** 

Tape and reel: 3000 pcs.

### **Dimensions**



## **Dimensions**

A = 0.30 x total number of positions + 2.10

 $\mathbf{B} = 0.30 \text{ x total number of positions } -0.30$ 

C = 0.30 x total number of positions - 0.90

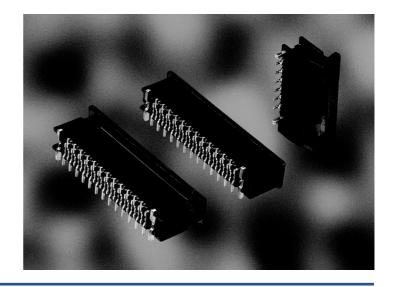
Circuitry Type For Recommended Circuitry type see page 27



## 0.50 mm Spacing for FFC / FPC

#### **Features**

- Available in 8, 12, 16, 20, 23, 24, 25, 30, 33 positions
- Straight
- Excellent cable retention with small size slider
- Cable lock option



#### **Benefits**

- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Zero Insertion Force (ZIF) connection allows an increased number of mating cycles with minimal wear.
- The ZIF pre-holding process provides a stable and reliable mating operation.
- The slider ensures maximum cable retention with a minimum size.
- Fork shaped contacts mean stable and low contact resistance.
- The cable lock option provides cable strain relief as well as full retention of cable.

### **Technical Data**

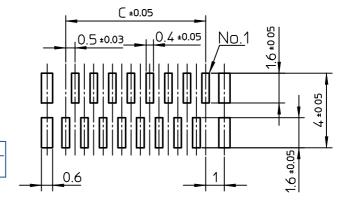
## PC Board pattern (component side)

#### **Material**

Housing: Resin, glass reinforced, UL94V-0, Black
Slider: Resin, glass reinforced, UL94V-0, Brown

(with cable-lock : Black)

Contact: Phosphor Bronze, Tin alloy plated



**Dimensions** 

C = 0.50 x total number of positions - 0.50



## 0.50 mm Spacing for FFC / FPC

## **Ordering Data**



**Number of contacts** 8, 12, 16, 20, 23, 24, 25, 30, 33

(for other number of positions, please contact FCI)

Cable lock 2 = without cable lock

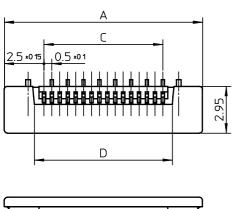
3 = with cable lock

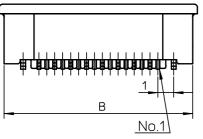
Packaging

Tape and reel: 1000 pcs.

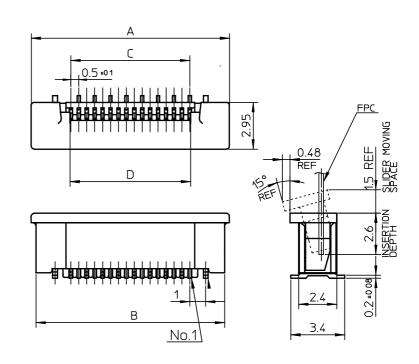
## **Dimensions**

## without cable lock





### with cable lock



Dimensions	
<b>A</b> = 0.50 x total number of positions + 4.50	±0.20
<b>B</b> = 0.50 x total number of positions + 3.90	±0.20
<b>C</b> = 0.50 x total number of positions - 0.50	±0.10
<b>D</b> (with cable lock) = $0.50 \times 10^{-2}$ x total number of positions - $0.40$	±0.10
<b>D</b> (without cable lock) = $0.50 \times total number of positions + 0.70 \times total number of positions)$	70 ±0.10

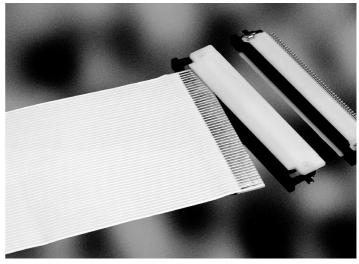
Circuitry Type For Recommended Circuitry type see page 27



## 0.50 mm Spacing for FPC / FPC

#### **Features**

- Available in 32, 34, 36, 40, 43, 45, 50 positions
- Right angle
- Excellent cable retention with small size slider



#### **Benefits**

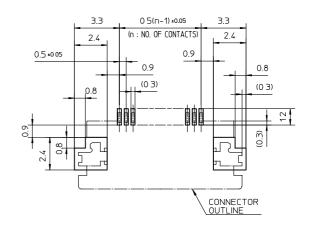
- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Zero Insertion Force (ZIF) connection allows an increased number of mating cycles with minimal wear.
- The ZIF pre-holding process provides a stable and reliable mating operation.
- The slider ensures maximum cable retention with a minimum size.
- Fork shaped contacts mean stable and low contact resistance.

### **Technical Data**

## PC Board pattern (component side)

#### **Material**

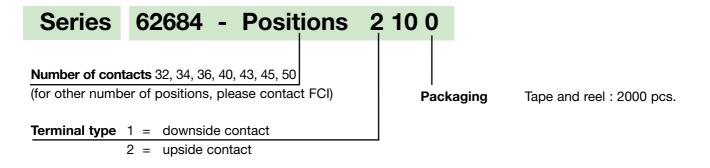
Housing: Glass filled thermoplastic, UL94V-0, Beige
Slider: Glass filled thermoplastic, UL94V-0, Black
Contact: Phosphor Bronze, Tin alloy plated



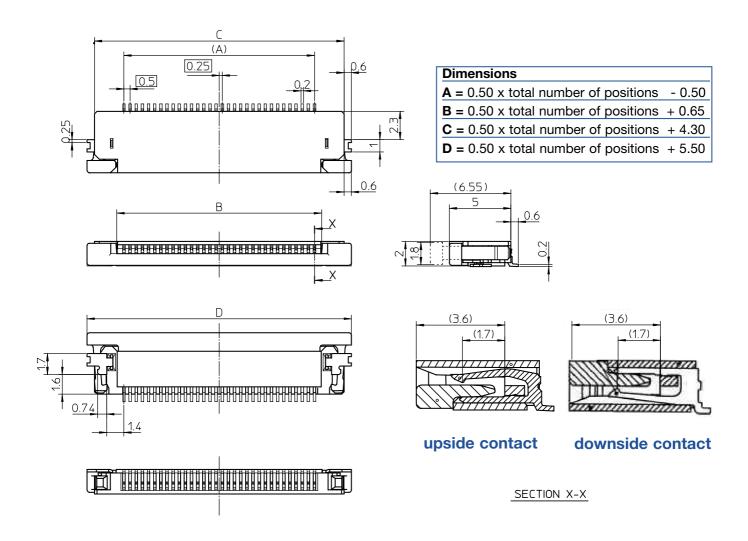


## 0.50 mm Spacing for FPC / FPC

## **Ordering Data**



### **Dimensions**



Circuitry Type For Recommended Circuitry type see page 28

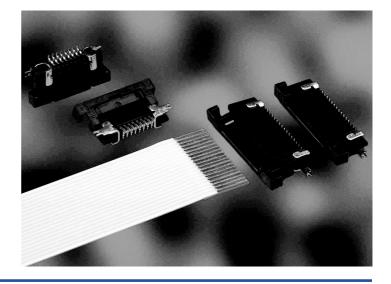
## SFV series - ZIF / SMT



## 0.50 mm Spacing for FFC / FPC

#### **Features**

- Available in 4 to 35 positions
- Right angle
- Cable lock option
- Top and bottom contacts
- Excellent cable retention with small size slider



#### **Benefits**

- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Zero Insertion Force (ZIF) connection allows an increased number of mating cycles with minimal wear.
- The ZIF pre-holding process provides a stable and reliable mating operation.
- The slider ensures maximum cable retention with a minimum size.
- The cable lock option provides cable strain relief as well as full retention of cable.
- Fork shaped contacts mean stable and low contact resistance.
- Product variations cover a broad range of applications.

#### **Technical Data**

PC Board pattern (component side)

#### **Material**

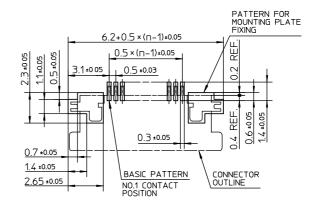
Housing: Polyamide Resin, glass reinforced, UL94V-0,

Black

Slider : PPS Resin, glass reinforced, UL94V-0, Brown

(with cable-lock : Black)

Contact: Phosphor Bronze, Tin alloy plated



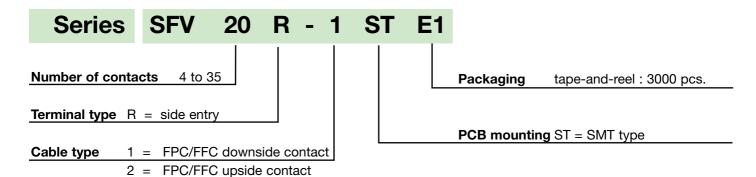
## SFV series - ZIF / SMT

3 = FPC (with cable-lock) downside contact 4 = FPC (with cable-lock) upside contact

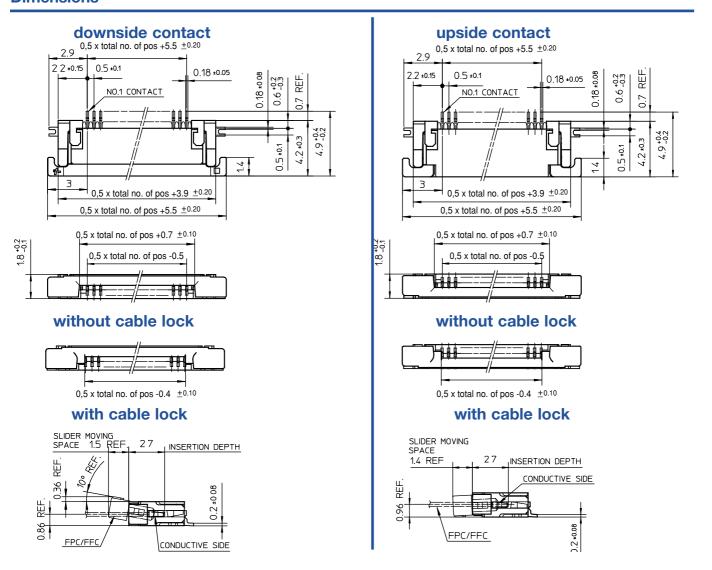


## 0.50 mm Spacing for FFC / FPC

## **Ordering Data**



### **Dimensions**



Circuitry Type For Recommended Circuitry type see page 28 and 29

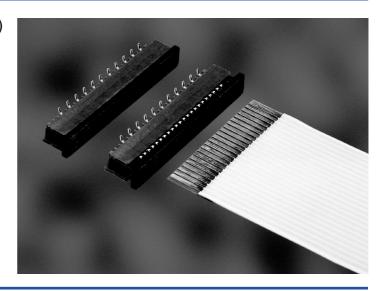
## SFW series - ZIF / SMT



## 1.00 mm Spacing for FFC / FPC / CIC

#### **Features**

- Available in 4 to 30 positions (right angle) and 4 to 32 positions (straight)
- Top and Bbottom contacts
- Cable lock option
- Optional mounting devices ( straight)
- Excellent cable retention with small size slider



#### **Benefits**

- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Zero Insertion Force (ZIF) connection allows an increased number of mating cycles with minimal wear.
- The ZIF pre-holding process provides a stable and reliable mating operation.
- The slider ensures maximum cable retention with a minimum size.
- The cable lock option provides cable strain relief as well as full retention of cable.
- Fork shaped contacts mean stable and low contact resistance.
- Product variations cover a broad range of application.
- Optional mounting devices provide PCB hold-down and strain relief for SMT tails, highly desirable for lower positions.

### **Technical Data**

### PC Board pattern (component side)

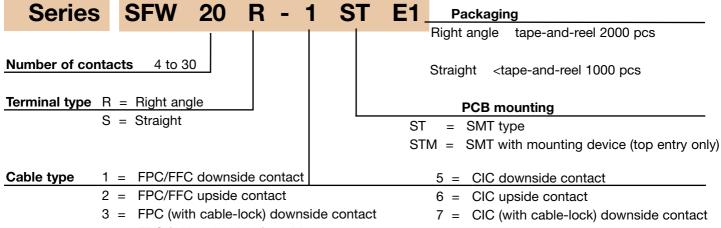
#### **Material Straight** Right angle Housing: For Right angle version: PPS, glass reinforced, UL94V-0 TERN FOR NTING PLATE For FPC / FCC: 1×(n−1)±0.05 housing color: Brown (with cable-lock: Black) PATTERN NO.1 CONTA POSITION slider color : Black (with cable-lock: Brown) For CIC: housing color: Brown (with cable-lock: Black) REF slider color : Black (with cable-lock: Brown) PATTERN For Vertical version: 1x(n-1) ±0 05 Heat-resisting Resin, glass reinforced, UL94V-0 0.7 ±0 05 1±0 05 housing color: Brown; slider color : Black 1 v (m + 1) + 0.05 Contact: Phosphor Bronze, Tin alloy plated

## SFW series - ZIF / SMT



## 1.00 mm Spacing for FFC / FPC / CIC

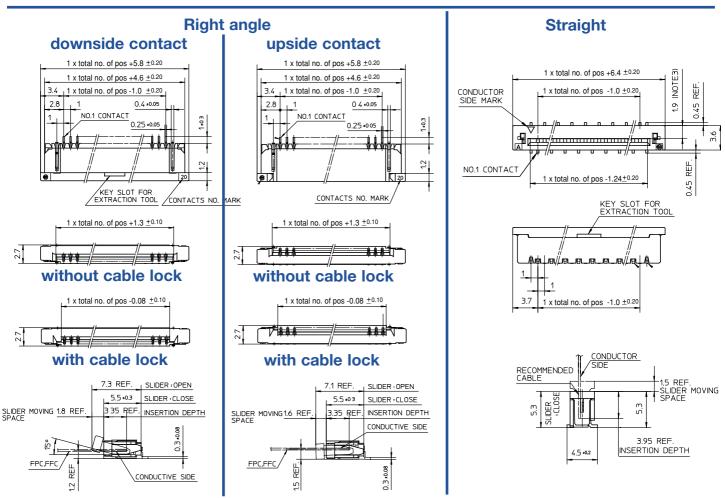
## **Ordering Data**



4 = FPC (with cable-lock) upside contact (cable types 1, 3, 4, 5, 7, 8 for side entry only)

8 = CIC (with cable-lock) upside contact

## **Dimensions**



Circuitry Type For Recommended Circuitry type see page 29 and 30

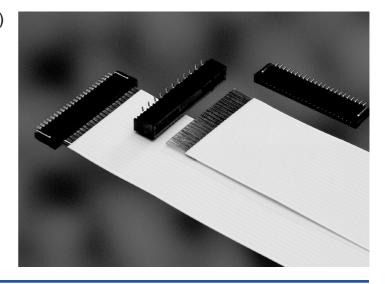
## HFW series - LIF / SMT



## 1.00 mm Spacing for FFC / FPC / CIC

### **Features**

- Available in 4 to 30 positions (right angle) and 4 to 33 positions (straight)
- Top and bottom contacts
- Optional mounting devices ( straight)

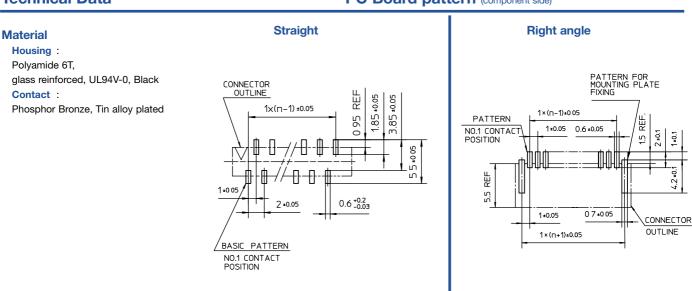


### **Benefits**

- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Low Insertion Force (LIF) contacts positioning provides a reliable and easy mating operation.
- Fork shaped contacts mean stable and low contact resistance.
- Optional mounting devices provide PCB hold-down and strain relief for SMT tails, highly desirable for lower positions.

### **Technical Data**

## PC Board pattern (component side)

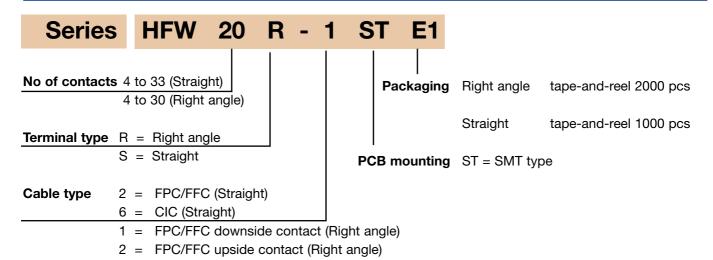


## HFW series - LIF / SMT

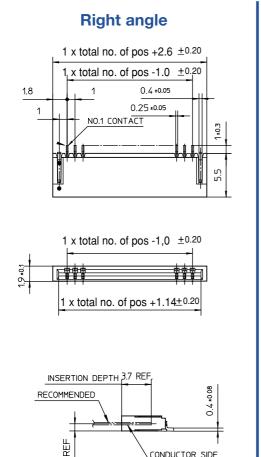


## 1.00 mm Spacing for FFC / FPC / CIC

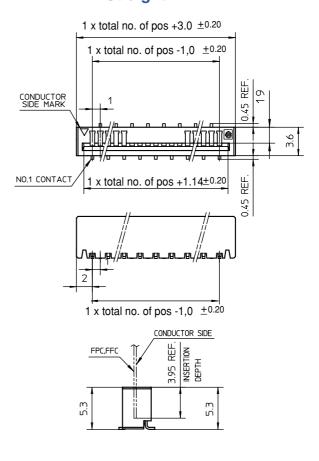
## **Ordering Data**



### **Dimensions**



## **Straight**



Circuitry Type For Recommended Circuitry type see page 30

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CONDUCTOR SIDE

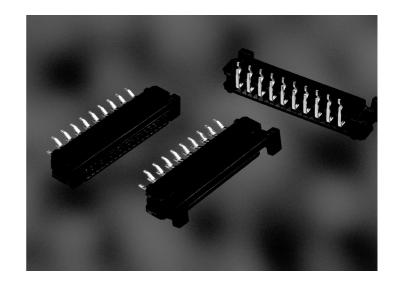
## SLW series - ZIF / Through hole



## 1.00 mm Spacing for FFC / FPC / CIC

#### **Features**

- Available in 4 to 30 positions
- Right angle or vertical type
- Excellent cable retention with small size slider
- Kinked solder tails available



#### **Benefits**

- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Zero Insertion Force connection allows an increased number of mating cycles with minimal wear.
- The ZIF pre-holding process provides a stable and reliable mating operation.
- The slider ensures maximum cable retention with a minimum size.
- Fork shaped contacts mean stable and low contact resistance.
- Kinked solder tails provide added PCB retention.
- Product variations cover a broad range of applications.

### **Technical Data**

PC Board pattern (component side)

#### **Material**

Housing:

Nylon, glass reinforced, UL94V-0, Black

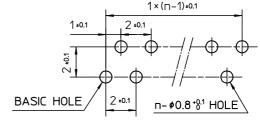
Slider

Nylon, glass reinforced, UL94V-0, Black

(For CIC: Milky-White)

Contact :

Phosphor Bronze, Tin alloy plated



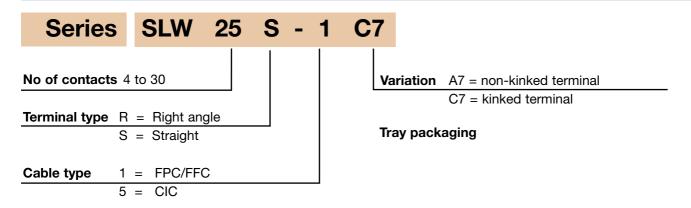
THICKNESS: 0.8~16

## SLW series - ZIF / Through hole

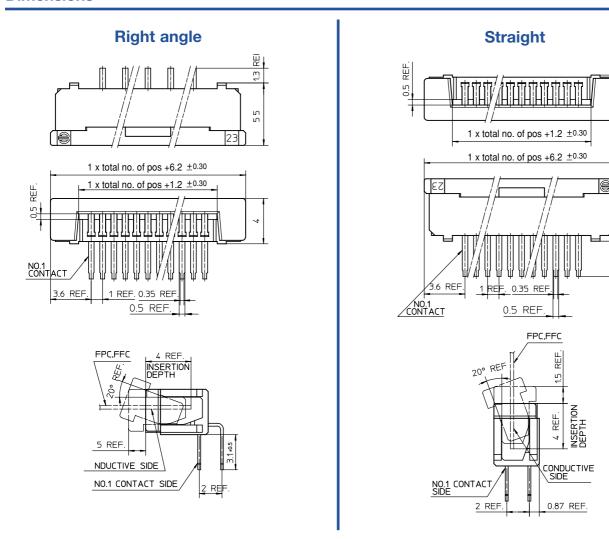


## 1.00 mm Spacing for FFC / FPC / CIC

## **Ordering Data**



### **Dimensions**



Circuitry Type For Recommended Circuitry type see page 31

REF.

5.5

3.1 ±0.5

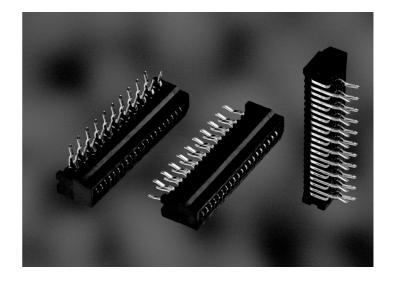
## **HLW** series - LIF / Through hole



## 1.00 mm Spacing for FFC / FPC / CIC

### **Features**

- Available in 4 to 32 positions
- Right angle and vertical type
- Kinked solder tails available



### **Benefits**

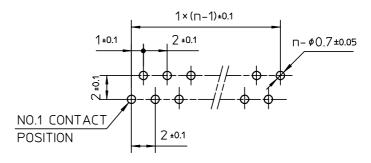
- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Low Insertion Force (LIF) contacts positioning provides a reliable and easy mating operation.
- Fork shaped contacts mean stable and low contact resistance.
- Kinked solder tails provide added PCB retention.

## **Technical Data**

PC Board pattern (component side)

#### **Material**

Housing: PBT, glass reinforced, UL94V-0, Black
Contact: Phosphor Bronze, Tin alloy plated



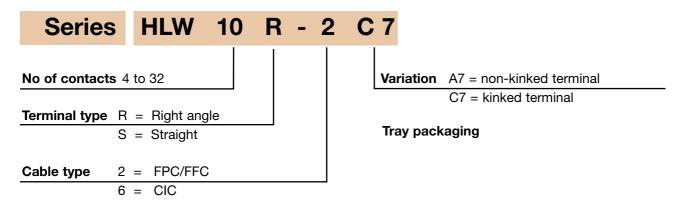
THICKNESS: 1.2~1.6

## **HLW** series - LIF / Through hole

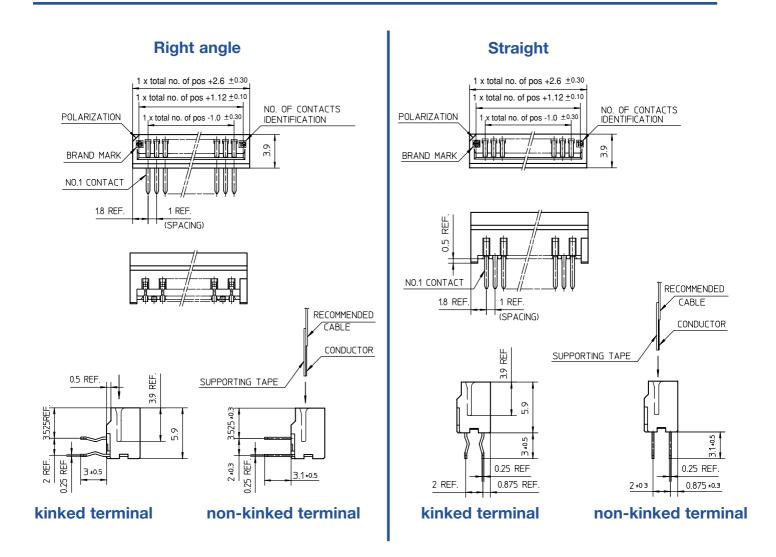


## 1.00 mm Spacing for FFC / FPC / CIC

## **Ordering Data**



### **Dimensions**



Circuitry Type For Recommended Circuitry type see page 31

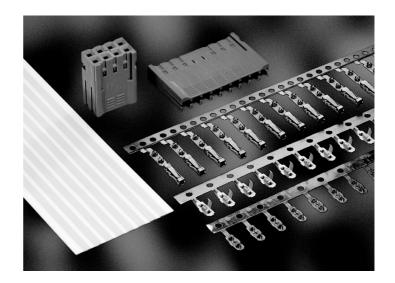
## **DUFLEX** series



## 2.54 mm Spacing for FFC / FPC / CIC

#### **Features**

- Available in 2 to 36 positions per row
- Single or double row
- Gold or tin plated option
- Gas tight
- Highly reliable Insulation Displacement Contact (IDC) termination technique
- Low-cost connection system
- Versatility
- Long-life contacts
- Mates with 0.62 mm square or round pins as short as 5 mm
- Dedicated application equipment



#### **Benefits**

- Ideal for large-volume users.
- Mass-termination reduces overall applied costs and time.
- Contacts fitting all housing styles ensures versatility and minimizes stock values.

### **Technical Data**

### Material

Housing: Thermoplastic Polyester, glass reinforced, UL94V-0, Blue Contact: Phosphor Bronze, Gold-duplex or Tin alloy plated

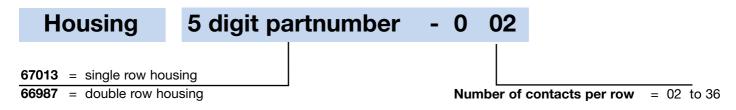
	Cable specification
Specification:	IPC Standard FC-220C. Cables type A or B
Thickness:	0.305 ±0.025 mm(0.012±0.0001 inch) incl. insulation
Insulation material:	Mylar, Kapton or Nomex (polyester/polyamide)
Conductor Thickness:	0.076 ±0.013 mm (0.003±0.0005 inch), 305 gr/m <sup>2</sup>
	0.127 ±0.013 mm (0.005±0.0005 inch), 610 gr/m <sup>2</sup>
Conductor width:	1.57 ± 0.07 mm (0.062±0.003 inch)
Conductor pitch:	2.54 ±0.05 mm (0.100±0.002 inch)
Thickness for	
non standard cable:	0.11 - 0.35 mm (0.004 - 0.013 inch)
Mating pin:	0.64 mm square (0.025 inch), min. 5.00 mm(0.196 inch) length
Cable specification and	application data sheet TA 338 and TA 333 on request

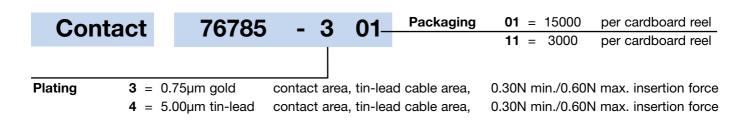
## **DUFLEX** series



## 2.54 mm Spacing for FFC / FPC / CIC

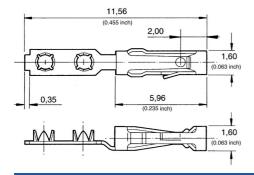
## **Ordering Data**



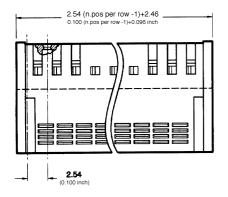


### **Dimensions**

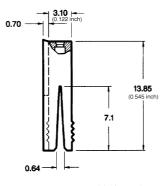
### **Contact**



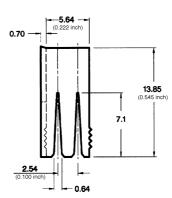
## **Housing**



## Single row



## **Double row**



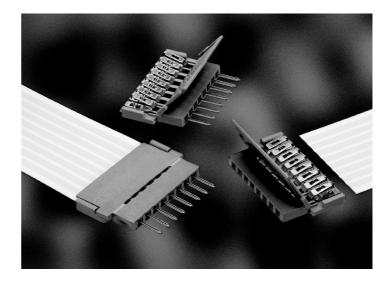
## **CLINCHER** series



# 2.54 mm Spacing for FFC / FPC / CIC

#### **Features**

- Available in 2 to 32 positions
- Gas-Tight, High pressure (GTH)
- Gold and tin plated option
- Pre-assembled
- Snap-shut
- Long-life contacts
- Mates with 0.62 mm square or round pins
- Dedicated application equipment



### **Benefits**

- Pre-assembled connectors reduce overall applied costs and ensure full contact protection.
- Snap-shut allows a single connection operation and therefore increases assembly speed.

## **Technical Data**

**Material** 

Housing: Polypropylene, glass reinforced, UL94V-0, Blue

Contact: brass, Gold or Tin alloy plated

	Cable specification
Specification:	IPC Standard FC-220C. Cables type A or B
Thickness:	0.305 ±0.025 mm(0.012±0.0001 inch) incl. insulation
Insulation material:	Mylar, Kapton or Nomex (polyester/polyamide)
Conductor Thickness:	0.076 ±0.013 mm (0.003±0.0005 inch), 305 gr/m <sup>2</sup>
	0.127 ±0.013 mm (0.005±0.0005 inch), 610 gr/m <sup>2</sup>
Conductor width:	1.57 ± 0.07 mm (0.062±0.003 inch)
Conductor pitch:	2.54 ±0.05 mm (0.100±0.002 inch)
Thickness for	
non standard cable:	0.11 - 0.35 mm (0.004 - 0.013 inch)
Mating pin:	0.64 mm square (0.025 inch), min. 5.00 mm(0.196 inch) length

## **CLINCHER** series



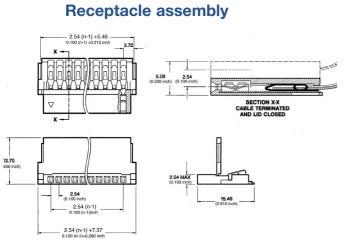
## 2.54 mm Spacing for FFC / FPC / CIC

## **Ordering Data**



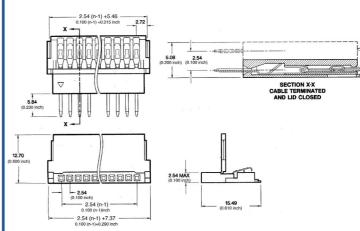
1 = for Thin film circuits (0.15 mm max. thickness) Receptacle only

### **Dimensions**



Gol	d p	lated		pla	ted
code	р	ositions	code	р	ositions
63	=	2 pos.	02	=	2 pos.
62	=	3 pos.	03	=	3 pos.
33	=	4 pos.	04	=	4 pos.
34	=	5 pos.	05	=	5 pos.
35	=	6 pos.	06	=	6 pos.
36	=	7 pos.	07	=	7 pos.
37	=	8 pos.	08	=	8 pos.
38	=	9 pos.	09	=	9 pos.
39	=	10 pos.	10	=	10 pos.
40	=	11 pos.	11	=	11 pos.
41	=	12 pos.	12	=	12 pos.
42	=	13 pos.	13	=	13 pos.
43	=	14 pos.	14	=	14 pos.
44	=	15 pos.	15	=	15 pos.
45	=	16 pos.	16	=	16 pos.
46	=	17 pos.	17	=	17 pos.
47	=	18 pos.	18	=	18 pos.
48	=	19 pos.	19	=	19 pos.
49	=	20 pos.	20	=	20 pos.
50	=	21 pos.	21	=	21 pos.
51	=	22 pos.	22	=	22 pos.
52	=	23 pos.	23	=	23 pos.
53	=	24 pos.	24	=	24 pos.
54	=	25 pos.	25	=	25 pos.
55	=	26 pos.	26	=	26 pos.
56	=	27 pos.	27	=	27 pos.
57	=	28 pos.	28	=	28 pos.
58	=	29 pos.	29	=	29 pos.
59	=	30 pos.	30	=	30 pos.
60	=	31 pos.	31	=	31 pos.
61	=	32 pos.	32	=	32 pos.
66	=	34 pos.	64	=	34 pos.

## Pin assembly



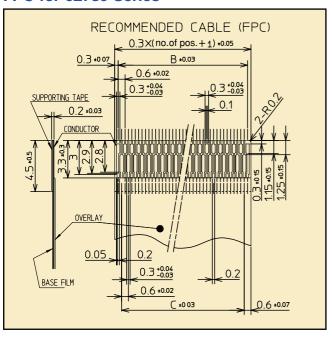
Gol	ld p	lated	Tin	pla	ted
code	р	ositions	code	р	ositions
34	=	2 pos.	02	=	2 pos.
35	=	3 pos.	03	=	3 pos.
36	=	4 pos.	04	=	4 pos.
37	=	5 pos.	05	=	5 pos.
38	=	6 pos.	06	=	6 pos.
39	=	7 pos.	07	=	7 pos.
40	=	8 pos.	08	=	8 pos.
41	=	9 pos.	09	=	9 pos.
42	=	10 pos.	10	=	10 pos.
43	=	11 pos.	11	=	11 pos.
44	=	12 pos.	12	=	12 pos.
45	=	13 pos.	13	=	13 pos.
46	=	14 pos.	14	=	14 pos.
47	=	15 pos.	15	=	15 pos.
48	=	16 pos.	16	=	16 pos.
49	=	17 pos.	17	=	17 pos.
50	=	18 pos.	18	=	18 pos.
51	=	19 pos.	19	=	19 pos.
52	=	20 pos.	20	=	20 pos.
53	=	21 pos.	21	=	21 pos.
54	=	22 pos.	22	=	22 pos.
55	=	23 pos.	23	=	23 pos.
56	=	24 pos.	24	=	24 pos.
57	=	25 pos.	25	=	25 pos.
58	=	26 pos.	26	=	26 pos.
59	=	27 pos.	27	=	27 pos.
60	=	28 pos.	28	=	28 pos.
61	=	29 pos.	29	=	29 pos.
62	=	30 pos.	30	=	30 pos.
63	=	31 pos.	31	=	31 pos.
64	=	32 pos.	32	=	32 pos.



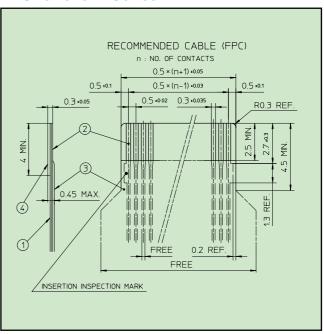
Polyamide or Polyester or Equivalent							
Number         Description         Material           ①         Base Film         Polyamide or Polyester or Equivalent           ②         Conductor         Copper Foil (Solder Plated 1 μm min.)           ③         Overlay         Polyamide or Polyester or Equivalent           ④         Supporting Tape         Polyamide or Polyester or Equivalent           Flexible Flexible Cable (FFC)           Number         Description         Material           ①         Insulation         Flame Resistant Polyester or Equivalent           ②         Conductor         Copper Foil (Tin or Solder Plated 1 μm min.)           ③         Supporting Tape         Flame Resistant Polyester or Equivalent           Conductive Ink Circuit (CIC)           Number         Description         Material           ①         Base Film         Polyester or Equivalent           ②         Conductor         Carbon Paste over Silver Paste           ③         Overlay         Polyamide or Polyester or Equivalent		Bill of Material					
1 Base Film Polyamide or Polyester or Equivalent 2 Conductor Copper Foil (Solder Plated 1 µm min.) 3 Overlay Polyamide or Polyester or Equivalent 4 Supporting Tape Polyamide or Polyester or Equivalent  Flexible Flexible Cable (FFC)  Number Description Material  1 Insulation Flame Resistant Polyester or Equivalent 2 Conductor Copper Foil (Tin or Solder Plated 1 µm min.) 3 Supporting Tape Flame Resistant Polyester or Equivalent  Conductive Ink Circuit (CIC)  Number Description Material  1 Base Film Polyester or Equivalent 2 Conductor Carbon Paste over Silver Paste 3 Overlay Polyamide or Polyester or Equivalent		Flexible Printed Circuit (FPC)					
2 Conductor Copper Foil (Solder Plated 1 μm min.) 3 Overlay Polyamide or Polyester or Equivalent 4 Supporting Tape Polyamide or Polyester or Equivalent  Flexible Flexible Cable (FFC)  Number Description Material  1 Insulation Flame Resistant Polyester or Equivalent 2 Conductor Copper Foil (Tin or Solder Plated 1 μm min.) 3 Supporting Tape Flame Resistant Polyester or Equivalent  Conductive Ink Circuit (CIC)  Number Description Material  1 Base Film Polyester or Equivalent 2 Conductor Carbon Paste over Silver Paste 3 Overlay Polyamide or Polyester or Equivalent	Number	Description	Material				
3 Overlay Polyamide or Polyester or Equivalent 4 Supporting Tape Polyamide or Polyester or Equivalent  Flexible Flexible Cable (FFC)  Number Description Material  1 Insulation Flame Resistant Polyester or Equivalent 2 Conductor Copper Foil (Tin or Solder Plated 1 μm min.) 3 Supporting Tape Flame Resistant Polyester or Equivalent  Conductive Ink Circuit (CIC)  Number Description Material  1 Base Film Polyester or Equivalent 2 Conductor Carbon Paste over Silver Paste 3 Overlay Polyamide or Polyester or Equivalent	1	Base Film	Polyamide or Polyester or Equivalent				
4 Supporting Tape Polyamide or Polyester or Equivalent  Flexible Flexible Cable (FFC)  Number Description Material  1 Insulation Flame Resistant Polyester or Equivalent 2 Conductor Copper Foil (Tin or Solder Plated 1 μm min.) 3 Supporting Tape Flame Resistant Polyester or Equivalent  Conductive Ink Circuit (CIC)  Number Description Material  1 Base Film Polyester or Equivalent  2 Conductor Carbon Paste over Silver Paste 3 Overlay Polyamide or Polyester or Equivalent	2	Conductor	Copper Foil (Solder Plated 1 µm min.)				
Flexible Flexible Cable (FFC)  Number  Description  Material  1 Insulation Flame Resistant Polyester or Equivalent 2 Conductor Copper Foil (Tin or Solder Plated 1 µm min.) 3 Supporting Tape Flame Resistant Polyester or Equivalent  Conductive Ink Circuit (CIC)  Number  Description  Material  1 Base Film Polyester or Equivalent 2 Conductor Carbon Paste over Silver Paste 3 Overlay Polyamide or Polyester or Equivalent	3	Overlay	Polyamide or Polyester or Equivalent				
Number         Description         Material           ①         Insulation         Flame Resistant Polyester or Equivalent           ②         Conductor         Copper Foil (Tin or Solder Plated 1 μm min.)           ③         Supporting Tape         Flame Resistant Polyester or Equivalent           Conductive Ink Circuit (CIC)           Number         Description         Material           ①         Base Film         Polyester or Equivalent           ②         Conductor         Carbon Paste over Silver Paste           ③         Overlay         Polyamide or Polyester or Equivalent	4	Supporting Tape	Polyamide or Polyester or Equivalent				
1 Insulation Flame Resistant Polyester or Equivalent 2 Conductor Copper Foil (Tin or Solder Plated 1 μm min.) 3 Supporting Tape Flame Resistant Polyester or Equivalent  Conductive Ink Circuit (CIC)  Number Description Material  1 Base Film Polyester or Equivalent 2 Conductor Carbon Paste over Silver Paste 3 Overlay Polyamide or Polyester or Equivalent		1	- · ·				
②       Conductor       Copper Foil (Tin or Solder Plated 1 μm min.)         ③       Supporting Tape       Flame Resistant Polyester or Equivalent         Conductive Ink Circuit (CIC)         Number       Description       Material         ①       Base Film       Polyester or Equivalent         ②       Conductor       Carbon Paste over Silver Paste         ③       Overlay       Polyamide or Polyester or Equivalent	Number	Description	Material				
Supporting Tape Flame Resistant Polyester or Equivalent  Conductive Ink Circuit (CIC)  Number Description Material  Base Film Polyester or Equivalent  Conductor Carbon Paste over Silver Paste  Overlay Polyamide or Polyester or Equivalent	1	Insulation	Flame Resistant Polyester or Equivalent				
Number     Description     Material       1     Base Film     Polyester or Equivalent       2     Conductor     Carbon Paste over Silver Paste       3     Overlay     Polyamide or Polyester or Equivalent	2	Conductor	Copper Foil (Tin or Solder Plated 1 µm min.)				
Number     Description     Material       ①     Base Film     Polyester or Equivalent       ②     Conductor     Carbon Paste over Silver Paste       ③     Overlay     Polyamide or Polyester or Equivalent	3	Supporting Tape	Flame Resistant Polyester or Equivalent				
1 Base Film Polyester or Equivalent 2 Conductor Carbon Paste over Silver Paste 3 Overlay Polyamide or Polyester or Equivalent		Conductive Ink Circuit (CIC)					
Conductor Carbon Paste over Silver Paste     Overlay Polyamide or Polyester or Equivalent	Number	Description	Material				
Overlay Polyamide or Polyester or Equivalent	1	Base Film	Polyester or Equivalent				
	2	Conductor	Carbon Paste over Silver Paste				
Supporting Tape Polyamide or Polyester or Equivalent		Overlay	Polyamide or Polyester or Equivalent				
	4	Supporting Tape	Polyamide or Polyester or Equivalent				



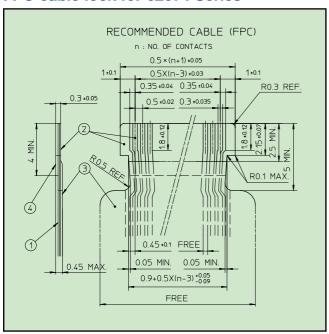
### FPC for 62789 Series



### FPC for 62674 Series

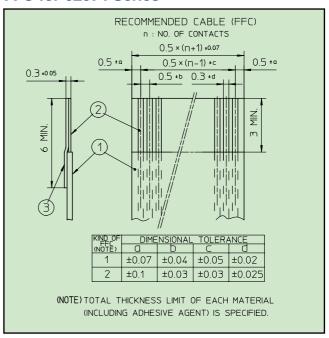


## FPC cable lock for 62674 Series



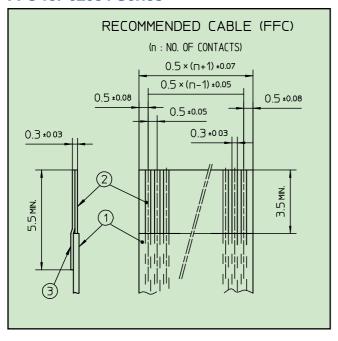
= for circled number description, please see page 26

### FFC for 62674 Series

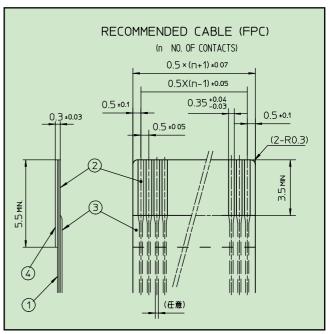




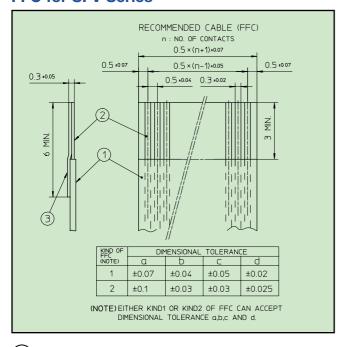
### FFC for 62684 Series



### FPC for 62684 Series

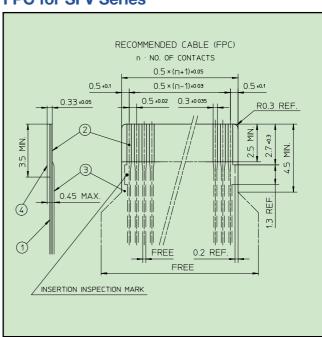


### **FFC for SFV Series**



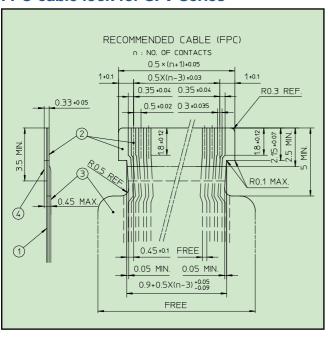
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### **FPC for SFV Series**

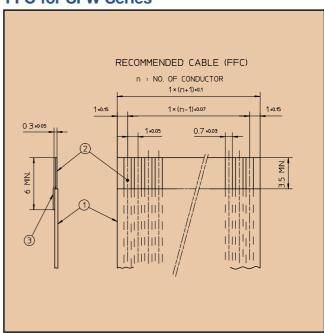




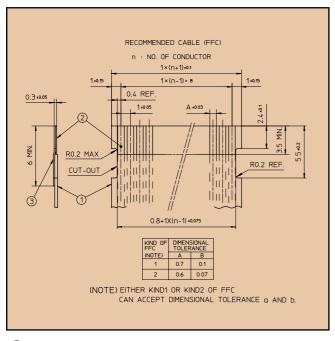
### **FPC** cable lock for SFV Series



### **FFC for SFW Series**

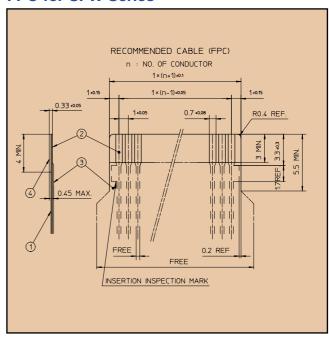


### FFC cable lock for SFW Series



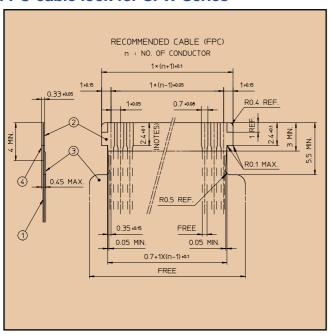
## = for circled number description, please see page 26

### **FPC for SFW Series**

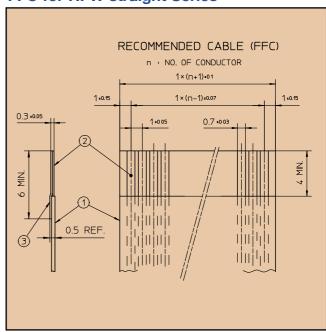




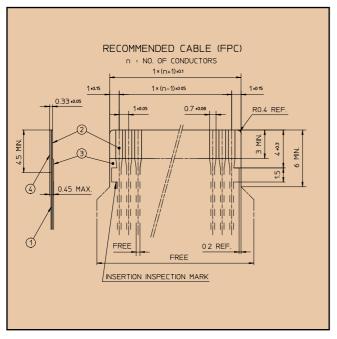
## **FPC** cable lock for SFW Series



## **FFC for HFW straight Series**

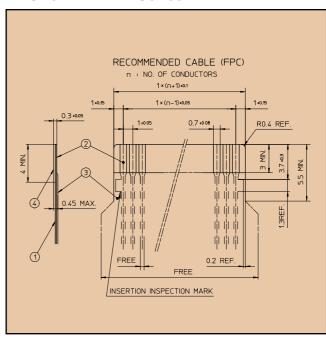


### **FPC for HFW straight Series**



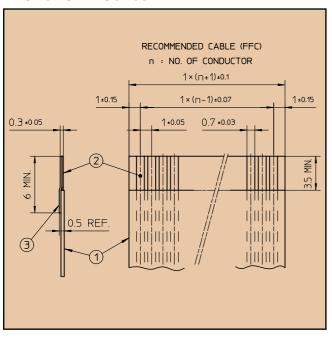
## = for circled number description, please see page 26

### **FPC for HFW RA Series**

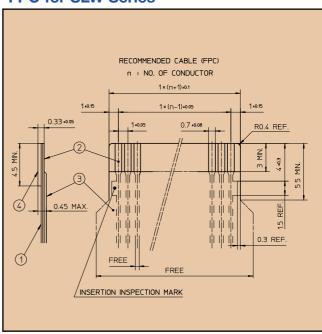




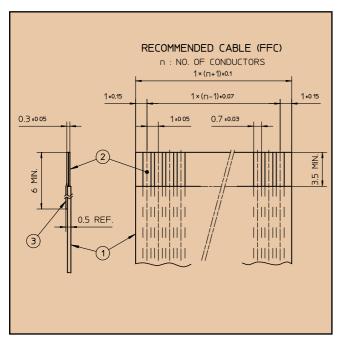
### **FFC for SLW Series**



### **FPC for SLW Series**

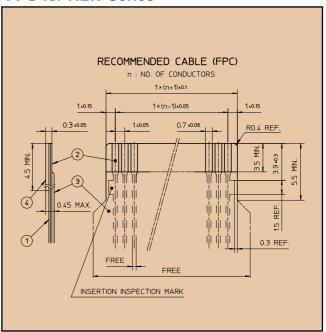


### **FFC for HLW Series**



## = for circled number description, please see page 26

## **FPC for HLW Series**





# **Performance characteristics**

Spacing	0.30 mm	0.50 mm	1.00 mm	2.54 mm	
- Optioning		0.00			
Circuitry	FPC	FFC / FPC	FFC / F	PC / CIC	
Series	62789	62674 62684 SFV	SFW HFW SLW HLW	DUFLEX CLINCHER	
Electrical					
Current Rating	0.5A	0.5A	1A	2A	
Rated Voltage (AC/DC)	50V	50V	100V	500V	
Contact Resistance (initial)	$30m\Omega$ max.	$30m\Omega$ max.	30m $Ω$ max.	30m $Ω$ max.	
Insulation Resistance	100M $\Omega$ min.	100M $\Omega$ min.	$500$ Μ $\Omega$ min.	5000M $\Omega$ min.	
Dielectic withstanding Voltage	AC 200VAC 2	200V AC 500\	V AC 1000V		
Mechanical					
Durability		Contact resistance	ce : 50mΩ max.		
Cycle	20	20	20 30 20 30	30	
Vibration		per JIS C 0040	No discontinuity greater than	η 1μ second	
Environmental					
Salt Spray		per JIS C 0023	Contact Resistance 50mg	2 max.	
Damp Heat		per JIS C 0022	Contact Resistance 50mg	2 max.	
(steady state)			Insulation Resistance 100mg	2 min.	
Change of Temperature		per JIS C 0025	Contact Resistance 50mΩ	2 max.	
Operating temperature Range			-55°C to +85°C		



# Series at a glance

Series	Pitch	Cable Type	ZIF / LIF	Soldering	Number of Positions
62789	0.30 mm	FPC	ZIF	SMT	27,33,39,45,51,57
62674 62684 SFV	0.50 mm 0.50 mm 0.50 mm	FFC/FPC FFC/FPC	ZIF ZIF ZIF	SMT SMT SMT	12,20,24,25,30 32,34,40,45,50 4 to 35
31 <b>V</b>	0.50 11111	110/110	<b>Z</b> II	Sivii	4 10 33
SFR HFR	0.80 mm 0.80 mm	FFC/FPC/CIC FFC/FPC/CIC	ZIF LIF	SMT SMT	4 to 30 4 to 30
SFW HFW SLW HLW	1.00 mm 1.00 mm 1.00 mm 1.00 mm	FFC/FPC/CIC FFC/FPC/CIC FFC/FPC/CIC	ZIF LIF ZIF LIF	SMT SMT DIP DIP	4 to 30 4 to 30 4 to 30 4 to 32
SFD SLD SLP SLEM HLEM	1.25 mm 1.25 mm 1.25 mm 1.25 mm 1.25 mm	FFC/FPC/CIC FFC/FPC/CIC FFC/FPC FFC/FPC	ZIF ZIF ZIF ZIF LIF	SMT DIP DIP DIP DIP	4,6,21,26 4 to 40 4 to 20 4 to 30 3 to 40
Clincher Duflex	2.54 mm 2.54 mm	FFC/FPC/CIC FFC/FPC/CIC	-	- -	2 to 32 2 to 72



# Notes



# Notes

AREVA, the world leader in nuclear power and connectors, is present in more than 30 countries.

The group's employees provide customers with a full range of products and services for electricity generation and develop connector products and interconnect systems mainly for the communications, data and automotive markets.

AREVA brings expertise and technologies for better living to meet the challenges of the 21st century: generalized access to energy and information, preservation of the planet, and responsible stewardship of resources for future generations.

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## FCI / Amphenol:

HFW13S-6STE1 HFW22S-6STE1 HFW24S-6STE1 HFW27S-2STE1 HFW30S-6STE1 HFW4S-6STE1 HFW9R-2STAE1LF 62789-671111CLF HFW17R-1STBE1LF HFW7R-2STE9LF HFW8R-2STE9LF HFW15R-1STE5LF HFW15R-2STE5LF HFW18R-1STE5LF HFW18R-2STE5LF HFW24R-1STE5LF HFW24R-2STE5LF HFW26R-1STE5LF HFW10R-5STE1HLF HFW6R-6STE1HLF